

#### **Automotive MOSFET**

#### OptiMOS™ 7 Power-Transistor







#### **Features**

- OptiMOS<sup>™</sup> power MOSFET for automotive applications
- N-channel Enhancement mode Normal Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- RoHS compliant
- 100% Avalanche tested

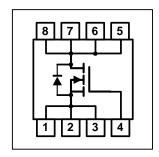
### **Potential applications**

General automotive applications.

#### **Product validation**

Qualified for automotive applications. Product validation according to AEC-Q101.





#### **Product Summary**

$V_{\mathrm{DS}}$	40	V
R <sub>DS(on)</sub>	3.02	mΩ
I <sub>D</sub> (chip limited)	100	Α

Туре	Package	Marking
IAUCN04S7N030	PG-TDSON-8-33	7N04N030

## IAUCN04S7N030



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# **Maximum ratings**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I D	V <sub>GS</sub> =10 V, Chip limitation <sup>1,2)</sup>	100	A
		V <sub>GS</sub> =10 V, DC current	100	
		$T_a$ =100 °C, $V_{GS}$ =10 V, $R_{thJA}$ on 2s2p <sup>2,3)</sup>	21	
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	T <sub>C</sub> =25 °C, t <sub>p</sub> = 100 μs	240	]
Avalanche energy, single pulse <sup>2)</sup>	E AS	/ <sub>D</sub> =24 A	40	mJ
Avalanche current, single pulse	I <sub>AS</sub>	-	47	А
Gate source voltage	V <sub>GS</sub>	-	±20	V
Power dissipation	P <sub>tot</sub>	Т <sub>C</sub> =25 °С	58	W
Operating and storage temperature	$T_{\rm j}$ , $T_{\rm stg}$	-	-55 <b>+1</b> 75	°C

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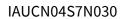
# Thermal characteristics<sup>2)</sup>

Parameter	Symbol Conditions		Values			Unit
			min.	typ.	max.	
Thermal resistance, junction - case	R thJC	-	-	1.3	2.6	K/W
Thermal resistance, junction - ambient <sup>3)</sup>	R <sub>thJA</sub>	-	-	29	-	

## **Electrical characteristics**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol Conditions	Values			Unit	
			min.	typ.	max.	
Static characteristics						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ =0 V, $I_D$ =1 mA	40	-	-	v
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 15 \mu A$	2.2	2.6	3.0	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{\rm DS}$ =40 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	_	-	1	μΑ
		$V_{DS}$ =40 V, $V_{GS}$ =0 V, $T_{j}$ =100 °C <sup>2</sup> )	_	-	4	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	-	-	100	nA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =7 V, I <sub>D</sub> =25 A	-	3.41	3.93	mΩ
		V <sub>GS</sub> =10 V, I <sub>D</sub> =50 A	-	2.71	3.02	
Gate resistance <sup>2)</sup>	R <sub>G</sub>	-	-	1.4	-	Ω





Parameter	Symbol Conditions		Values			Unit
			min.	typ.	max.	
Dynamic characteristics <sup>2)</sup>						
Input capacitance	C iss		-	1068	1389	pF
Output capacitance	C oss	$V_{GS}$ =0 V, $V_{DS}$ =20 V, $f$ =1 MHz	-	623	810	
Reverse transfer capacitance	C <sub>rss</sub>		-	24	36	
Turn-on delay time	t d(on)		-	3.3	_	ns
Rise time	t <sub>r</sub>	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A,	-	1.0	_	
Turn-off delay time	t <sub>d(off)</sub>	$R_{\rm G}$ =3.5 $\Omega$	-	6.2	_	
Fall time	t <sub>f</sub>		_	3.4	_	
Gate to drain charge  Cate charge total	Q gs Q gd	$V_{DD}$ =20 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 10 V	-	3	5	nC
Gate charge total	Q <sub>g</sub>		-	16	20	
Gate plateau voltage	$V_{\rm plateau}$		-	4.5	_	V
Reverse Diode						
Diode continous forward current <sup>2)</sup>	Is	T <sub>C</sub> =25 °C	-	-	100	Α
Diode pulse current <sup>2)</sup>	I <sub>S,pulse</sub>	T <sub>C</sub> =25 °C, t <sub>p</sub> = 100 μs	-	-	240	
Diode forward voltage	$V_{SD}$	$V_{GS}$ =0 V, $I_{F}$ =50 A, $T_{j}$ =25 °C	-	0.8	0.95	V
Reverse recovery time <sup>2)</sup>	t rr	V <sub>R</sub> =20 V, I <sub>F</sub> =50A,	-	16	24	ns
Reverse recovery charge <sup>2)</sup>	Q <sub>rr</sub>	$di_F/dt = 100 A/\mu s$	_	3.2	6.4	nC

<sup>1)</sup> Practically the current is limited by the overall system design including the customer-specific PCB.

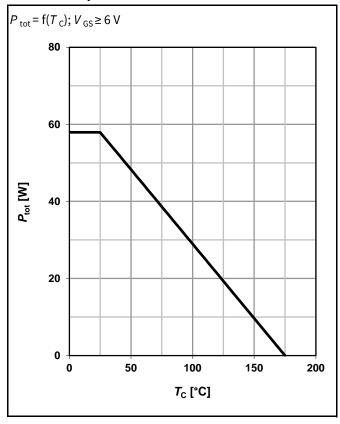
 $<sup>^{\</sup>rm 2)}$  The parameter is not subject to production testing – specified by design.

<sup>&</sup>lt;sup>3)</sup> Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

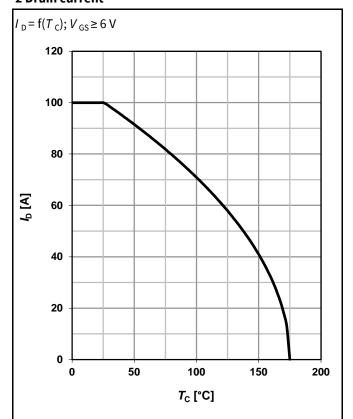


## **Electrical characteristics diagrams**

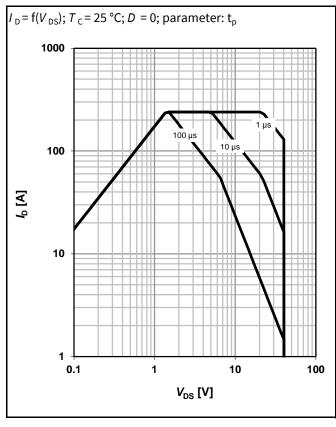
#### 1 Power dissipation



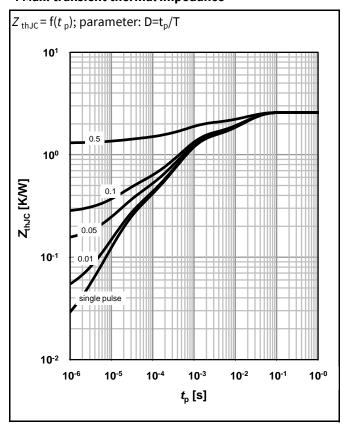
### 2 Drain current



#### 3 Safe operating area



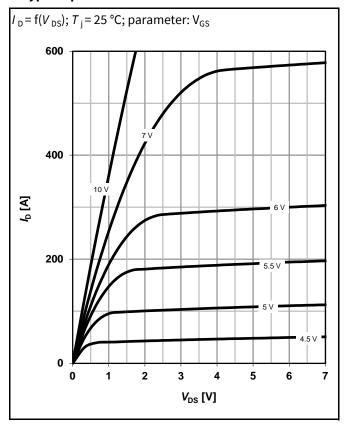
#### 4 Max. transient thermal impedance



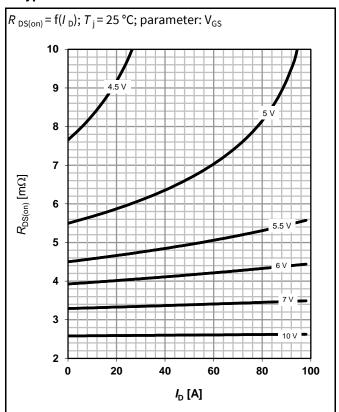
6



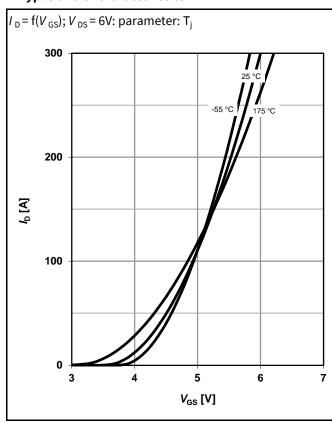
#### 5 Typ. output characteristics



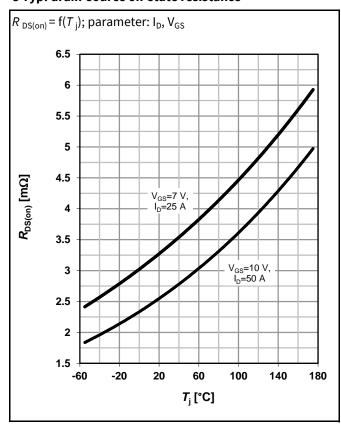
#### 6 Typ. drain-source on-state resistance



#### 7 Typ. transfer characteristics

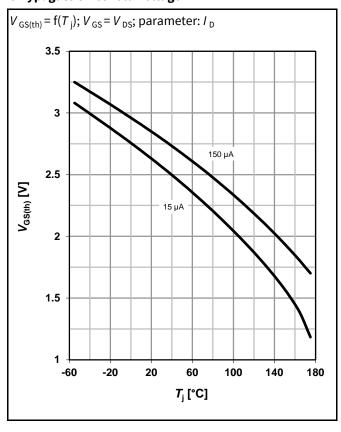


### 8 Typ. drain-source on-state resistance

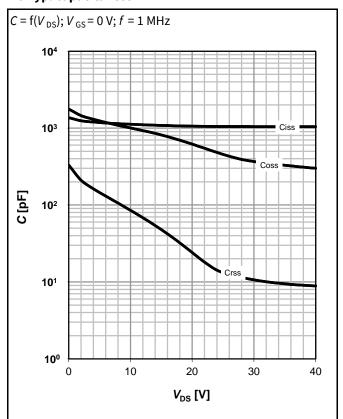


# infineon

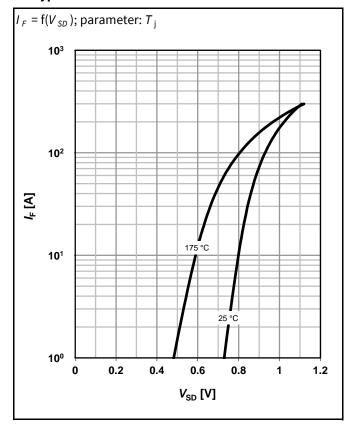
### 9 Typ. gate threshold voltage



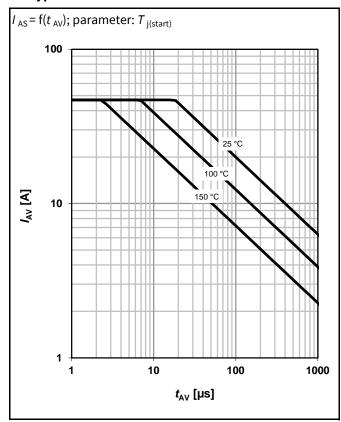
### 10 Typ. capacitances



#### 11 Typical forward diode characteristics

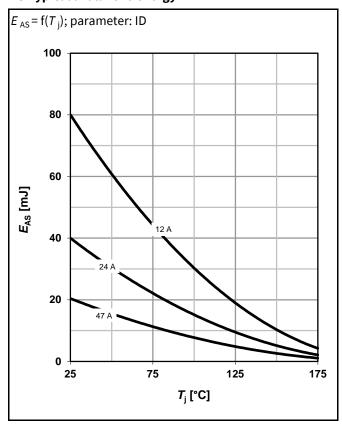


#### 12 Typ. avalanche characteristics

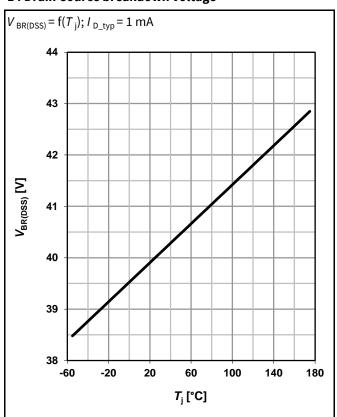


# infineon

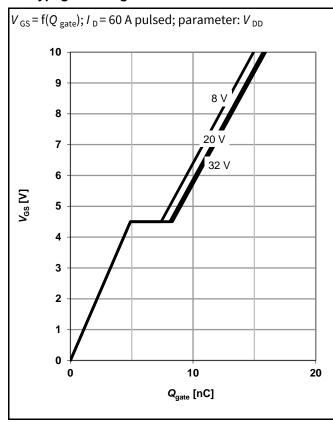
### 13 Typical avalanche energy



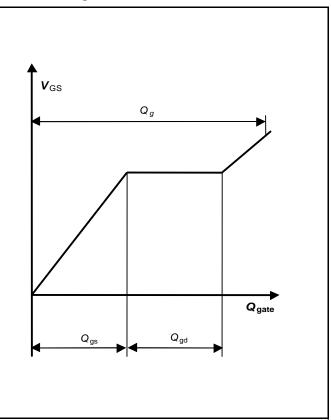
#### 14 Drain-source breakdown voltage



#### 15 Typ. gate charge

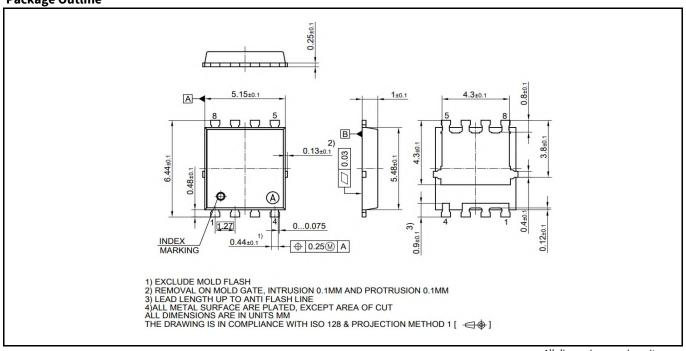


### 16 Gate charge waveforms



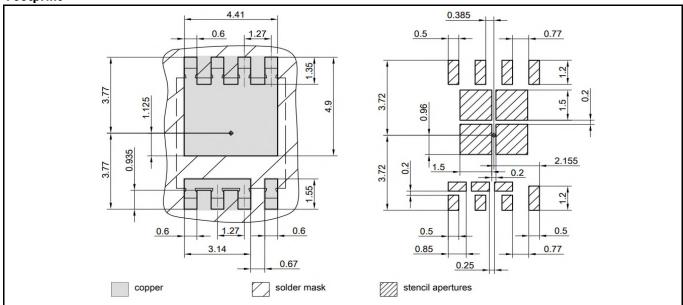


**Package Outline** 



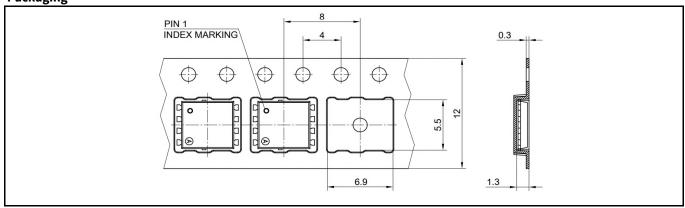
All dimensions are in units mm

#### **Footprint**



All dimensions are in units mm

#### **Packaging**



All dimensions are in units mm

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## **Revision History**

Revision	Date	Changes	
Revision 1.0	15.11.2023	Final Data Sheet	

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